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DS38EP100 1 to 5 Gbps, Power-Saver Equalizer for Backplanes and Cables

Check for Samples: DS38EP100

FEATURES

- 1 to 5 Gbps Operation
- No Power or Ground Required
- Equalization Effective Anywhere in Data Path
- Equalizes CML, LV-PECL, LVDS Signals
- Symmetric I/O Structures Provide Equal Boost for Bi-directional Operation
- 7 dB Maximum Boost
- Code Independent, 8b/10b or Scrambled
- Supports Both Bi-level and Multi-level Signaling
- Extends Reach Over Backplanes and Cables
- Compatible with PCI-Express Gen1 and Gen2
- Compatible with XAUI
- Operates in Series with Existing Active Equalizer
- Easy to Handle 6 Pin WSON

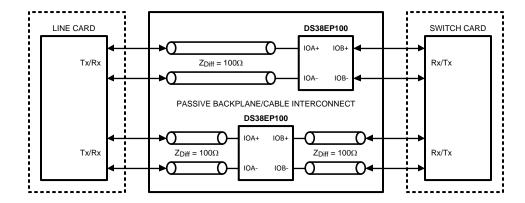
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Simplified Application Diagram

DESCRIPTION

TI's Power-saver equalizer compensates for transmission medium losses and minimizes medium-induced deterministic jitter. Performance is ensured over the full range of 1 to 5 Gbps. The DS38EP100 requires no power to operate. The equalizer operates anywhere in the data path to minimize media-induced deterministic jitter in both FR4 and cable applications. Symmetric I/O structures support full duplex or half duplex applications. Linear compensation is provided independent of line coding or protocol. The device is ideal for both bi-level and multi-level signaling.

The equalizer is available in a 6 pin leadless WSON package with a space saving 2.2 mm X 2.5 mm footprint. This tiny package provides maximum flexibility in placement and routing of the Power-saver equalizer.



NOTE

The DS38EP100 provides the flexibility of passing the data from either side of the device. It can be placed anywhere in the data path..

ATA

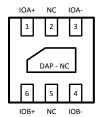
Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



PIN DESCRIPTIONS

Pin Name	Pin Number	I/O, Type	Description	
High Speed Differ	ential I/O			
IOA- IOA+	3	I/O	Symmetric differential I/O.	
IOB- IOB+	4 6	I/O	Symmetric differential I/O.	
NC Exposed Pad	2, 5 DAP	N/A	Reserved. Do not connect.	

Pin Diagram



2.2mm × 2.5mm 6-Pin WSON Package Bottom View



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Absolute Maximum Ratings (1)(2)

+2V
+4V
+4V
+150°C
−65°C to +150°C
+260°C
1.3kV

- (1) "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur, including inoperability and degradation of device reliability and/or performance. Functional operation of the device and/or non-degradation at the Absolute Maximum Ratings or other conditions beyond those indicated in the Recommended Operating Conditions is not implied. The Recommended Operating Conditions indicate conditions at which the device is functional and the device should not be operated beyond such conditions.
- (2) If Military/Aerospace specified devices are required, please contact the TI Sales Office/Distributors for availability and specifications.

Recommended Operating Conditions

	Min	Тур	Max	Units
Operating Temperature	-40	25	+85	°C
Bit Rate	1		5	Gbps



Electrical Characteristics (1)

Over recommended operating conditions unless other specified. All parameters are ensured by test, statistical analysis or design.

Parameter	Parameter Conditions		Typ (2)	Max	Units	
Input voltage swing	See (3)		1000	3600	mVp-p	
Equalization	2.5 GHz relative to 100MHz		6		dB	
Differential input return loss	100 MHz – 2.5 GHz, with fixture's effect de- embedded		15		dB	
Differential output return loss	100 MHz – 2.5 GHz, with fixture's effect de- embedded. IOA+,or IOB+ = static high.		15		dB	
Input Impedance	Differential across IOA+ and IOA-, or IOB+ and IOB-, ZLOAD = 100Ω		100		Ω	
Output Impedance	Differential across IOA+ and IOA-, or IOB+ and IOB-, ZSOURCE = 100Ω		100		Ω	
Through Response	Relative to ideal load, see Figure 2 for setup	See Figure 3	and Table 1	for limits		
Resistance IOA+ to IOA- and IOB+ to IOB-	No load, high impedance on all ports		150		Ω	
Resistance IOA+ to IOB+ and IOA- to IOB-	No load, high impedance on all ports		50		Ω	
Resistance IOA+ to IOB- and IOA- to IOB+	No load, high impedance on all ports		150		Ω	
DC Gain			0.4			
(IOA/IOB or IOB/IOA)	$^{Z}LOAD = 100\Omega$		0.4			
Residual deterministic	2.5 Gbps, 40 in of 6mil microstrip FR4		0.1		Ulp-p	
jitter	See (4)		0.1		Olb-b	
Residual deterministic jitter	3.125 Gbps, 40 in of 6mil microstrip FR4 See (4) (5)		0.1	0.15	Ulp-p	
Residual deterministic	3.8 Gbps, 40 in of 6mil microstrip FR4 See (4) (5)		0.1	0.15	Ulp-p	
Residual deterministic iitter	5 Gbps, 30 in of 6mil microstrip FR4 See (4)		0.1		Ulp-p	
	Input voltage swing Equalization Differential input return loss Differential output return loss Input Impedance Output Impedance Through Response Resistance IOA+ to IOA- and IOB+ to IOB- Resistance IOA+ to IOB+ and IOA- to IOB+ DC Gain (IOA/IOB or IOB/IOA) Residual deterministic jitter Residual deterministic jitter Residual deterministic jitter Residual deterministic	Input voltage swing See (3)	Input voltage swing See (3)	Input voltage swing See (3) 1000	Input voltage swing Equalization 2.5 GHz relative to 100MHz 100 MHz – 2.5 GHz, with fixture's effect deembedded Differential output return loss Differential output return loss Input Impedance Input Impedance Differential across IOA+ and IOA-, or IOB+ and IOB-, ZLOAD = 100Ω Uutput Impedance Differential across IOA+ and IOA-, or IOB+ and IOB-, ZSOURCE = 100Ω Through Response Resistance IOA+ to IOB- Resistance IOA+ to IOB- and IOA- to IOB- and IOA- to IOB- and IOA- to IOB- Resistance IOA+ to IOB- and IOA- to IOB- DC Gain (IOA/IOB or IOB/IOA) Residual deterministic jitter See (4) (5) See Gaps, 30 in of 6mil microstrip FR4 See (4) (5) See Gaps, 30 in of 6mil microstrip FR4 See (4) (5) Residual deterministic jitter Residual deterministic jitter See (4) (5) See Gaps, 30 in of 6mil microstrip FR4 See (4) (5) See Gaps, 30 in of 6mil microstrip FR4	

⁽¹⁾ The Electrical Characteristics tables list ensured specifications under the listed Recommended Operating Conditions except as otherwise modified or specified by the Electrical Characteristics Conditions and/or Notes. Typical specifications are estimations only and are not ensured.

(5) Specification is ensured by characterization and is not tested in production.

⁽²⁾ Typical values represent most likely parametric norms, TA = +25 degC, and at the Recommended Operating Conditions at the time of product characterization and are not ensured.

⁽³⁾ Differential signal to Equalizer, measured at the input to a transmission line, see point A of Figure 1. The transmission line is Z₀ = 100Ω, 6-mil, microstrip in FR4 material.

⁽⁴⁾ Deterministic jitter is measured at the differential outputs (point C of Figure 1), minus the deterministic jitter before the test channel (point A of Figure 1). Test pattern: PRBS- 7.



Test Setup Diagrams

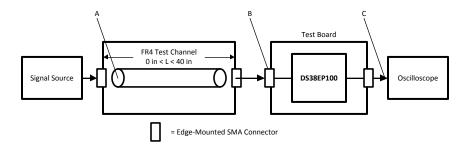


Figure 1. Transient Test Setup Diagram

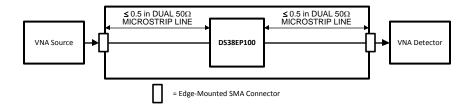


Figure 2. Frequency Response Test Circuit

Typical Equalizer Transfer Function

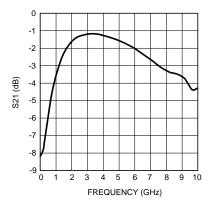


Figure 3. Typical Equalizer Transfer Function



Table 1. Typical Through Response

Frequency (GHz)	DS38EP100 Attenuation Typ (dB)
0.1	-7.98
0.5	-5.93
1	-3.53
1.5	-2.25
2	-1.58
3	-1.14
4	-1.26
5	-1.54
6	-1.99
7	-2.62
8	-3.26
9	-3.61
10	-4.26

Block Diagram

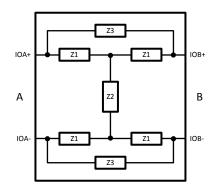


Figure 4. Simplified Block Diagram

APPLICATION INFORMATION

DS38EP100 DEVICE DESCRIPTION

The DS38EP100 Power-Saver equalizer is a passive network circuit composed of resistive, capacitive, and inductive components (See Figure 4). A differential bridged T-network compensates for the transmission medium losses and minimizes medium-induced deterministic jitter with FR4 and cables. The equalizer attenuates low frequency signals and is a bandpass filter at the resonant frequency. The response is linear and symmetric.

I/O TERMINATIONS

The DS38EP100 I/O impedance is 100Ω differential. The equalizer is designed for 100Ω -balanced differential signals and is not intended for single-ended transmission.

LINEAR COMPENSATION

The unique linear compensation feature of the DS38EP100 combined with the tiny package allows maximum flexibility in placement. The equalizer can be placed anywhere in the data path and will provide the same compensation at the receiving circuit. (See Simplified Application Diagram)

SYMMETRIC I/O STRUCTURES

The symmetry of the passive equalization network allows bi-directional operation. Signals receive equal compensation regardless of the direction of data flow. (See Figure 4).

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PCB LAYOUT CONSIDERATIONS FOR DIFFERENTIAL PAIRS AND NO CONNECT PADS

The differential I/Os must have a controlled differential impedance of 100Ω . It is preferable to route all differential lines exclusively on one layer of the board. The use of vias should be avoided if possible. If vias must be used, they should be used sparingly and must be placed symmetrically for each side of a given differential pair. Differential signals should be routed away from other signals and noise sources on the printed circuit board. Pin 2, Pin 5, and the center DAP have to be left as a no connect. Therefore, do not connect the landing pads of these pins to the power or ground plane. See AN-1187 (SNOA401) for additional information on the WSON package.

TYPICAL PERFORMANCE CHARACTERISTICS

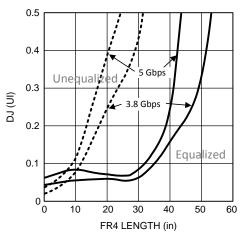
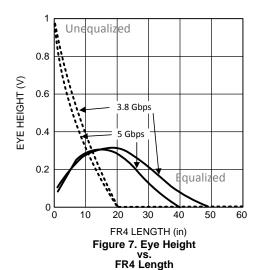


Figure 5. Residual Deterministic Jitter vs. FR4 Length



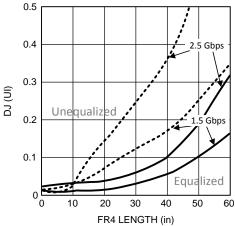


Figure 6. Residual Deterministic Jitter vs. FR4 Length

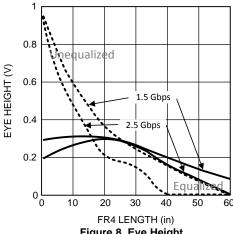


Figure 8. Eye Height vs. FR4 Length



TYPICAL PERFORMANCE CHARACTERISTICS (continued) Typical Eye Diagrams — Includes Transmitter Setup, Interconnect, and Device Total Jitter

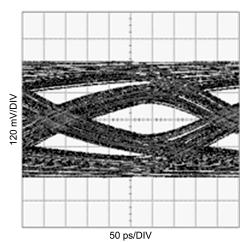


Figure 9. Unequalized Signal (40in FR4, 2.5Gbps, PRBS7)

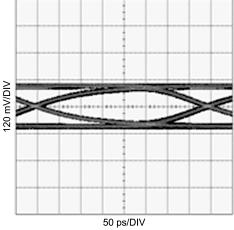


Figure 10. Equalized Signal (40in FR4, 2.5Gbps, PRBS7)

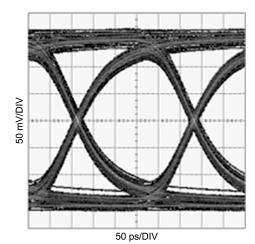


Figure 11. Equalized Signal (Zoom) (40in FR4, 2.5Gbps, PRBS7)

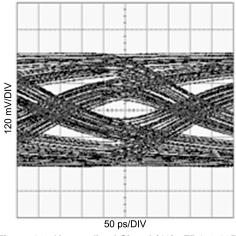


Figure 12. Unequalized Signal (40in FR4, 3.125Gbps, PRBS7)

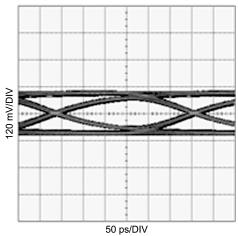


Figure 13. Equalized Signal (40in FR4, 3.125Gbps, PRBS7)

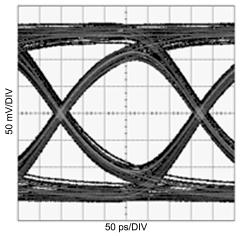


Figure 14. Equalized Signal (Zoom) (40in FR4, 3.125Gbps, PRBS7)



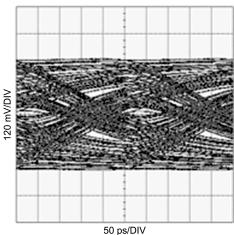


Figure 15. Unequalized Signal (40in FR4, 3.8Gbps, PRBS7)

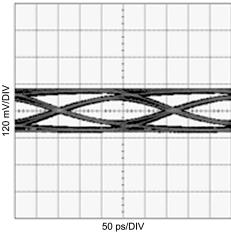


Figure 16. Equalized Signal (40in FR4, 3.8Gbps, PRBS7)

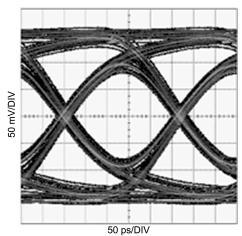


Figure 17. Equalized Signal (Zoom) (40in FR4, 3.8Gbps, PRBS7)

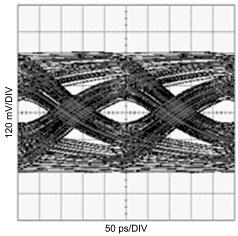


Figure 18. Unequalized Signal (30in FR4, 4.25Gbps, PRBS7)

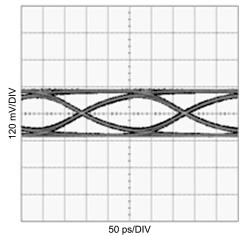


Figure 19. Equalized Signal (30in FR4, 4.25Gbps, PRBS7)

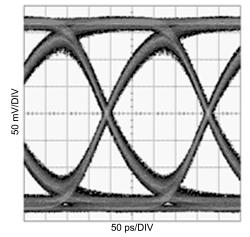


Figure 20. Equalized Signal (Zoom) (30in FR4, 4.25Gbps, PRBS7)



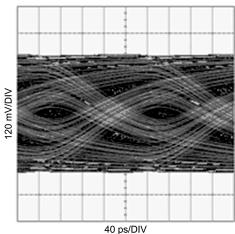


Figure 21. Unequalized Signal (30in FR4, 5Gbps, PRBS7)

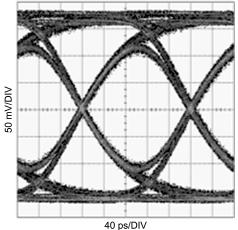


Figure 23. Equalized Signal (Zoom) (30in FR4, 5Gbps, PRBS7)

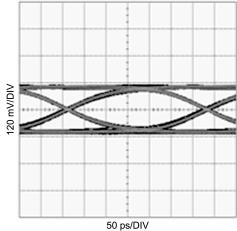


Figure 25. Equalized Signal (34in Tyco XAUI Backplane, 3.125Gbps, PRBS7)

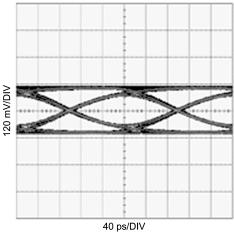


Figure 22. Equalized Signal (30in FR4, 5Gbps, PRBS7)

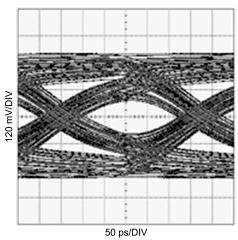


Figure 24. Unequalized Signal (34in Tyco XAUI Backplane, 3.125Gbps, PRBS7)

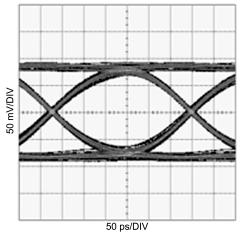


Figure 26. Equalized Signal (Zoom) (34in Tyco XAUI Backplane, 3.125Gbps, PRBS7)



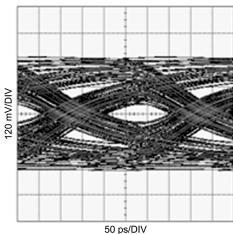
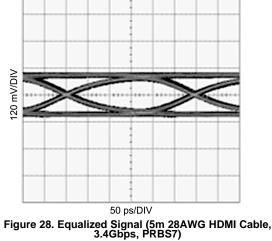


Figure 27. Unequalized Signal (5m 28AWG HDMI Cable, 3.4Gbps, PRBS7)



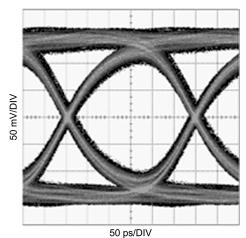


Figure 29. Equalized Signal (Zoom) (5m 28AWG HDMI Cable, 3.4Gbps, PRBS7)

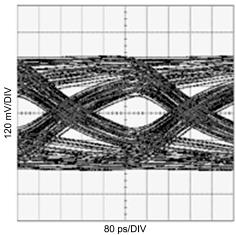


Figure 30. Unequalized Signal (10m 26AWG HDMI Cable, 2.25Gbps, PRBS7)

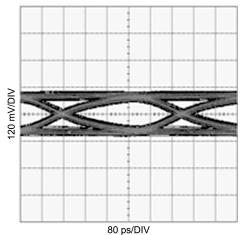


Figure 31. Equalized Signal (10m 26AWG HDMI Cable, 2.25Gbps, PRBS7)

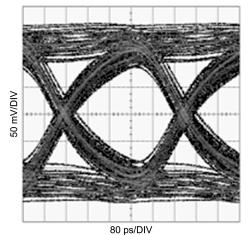


Figure 32. Equalized Signal (Zoom) (10m 26AWG HDMI Cable, 2.25Gbps, PRBS7)



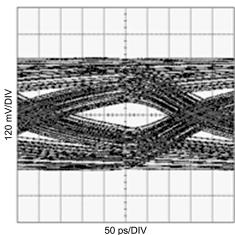
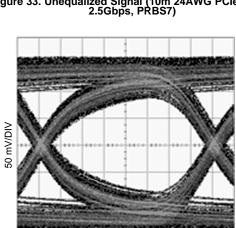


Figure 33. Unequalized Signal (10m 24AWG PCle Cable, 2.5Gbps, PRBS7)



50 ps/DIV Figure 35. Equalized Signal (Zoom) (10m 24AWG PCle Cable, 2.5Gbps, PRBS7)

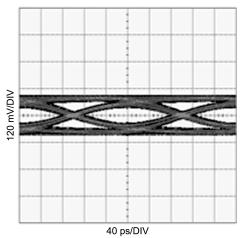


Figure 37. Equalized Signal (10m 24AWG PCle Cable, 5Gbps, PRBS7)

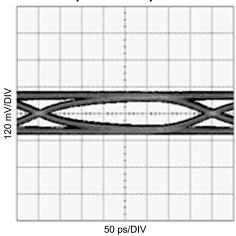


Figure 34. Equalized Signal (10m 24AWG PCle Cable, 2.5Gbps, PRBS7)

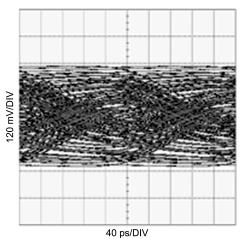


Figure 36. Unequalized Signal (10m 24AWG PCle Cable, 5Gbps, PRBS7)

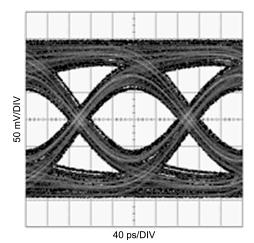


Figure 38. Equalized Signal (Zoom) (10m 24AWG PCle Cable, 5Gbps, PRBS7)

SNLS278C -JULY 2007-REVISED APRIL 2013



REVISION HISTORY

Cr	anges from Revision B (April 2013) to Revision C Changed layout of National Data Sheet to TI format	Pag	ge
•	Changed layout of National Data Sheet to TI format		11

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PACKAGING INFORMATION

Orderable part number	Status	Material type	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
						(4)	(5)		
DS38EP100SD/NOPB	Active	Production	WSON (NGF) 6	1000 SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	38S
DS38EP100SD/NOPB.A	Active	Production	WSON (NGF) 6	1000 SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	38S

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

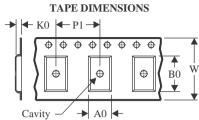
⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

PACKAGE MATERIALS INFORMATION

www.ti.com 1-Aug-2025

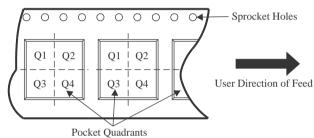
TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

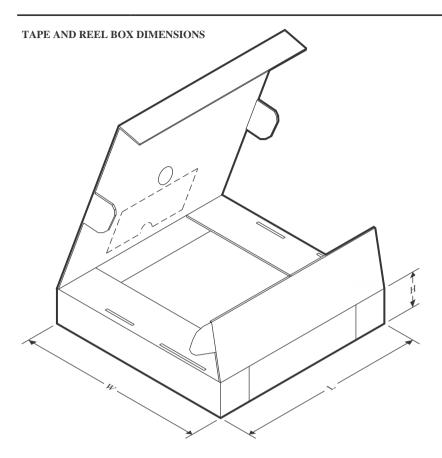


*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
DS38EP100SD/NOPB	WSON	NGF	6	1000	177.8	12.4	2.8	2.5	1.0	8.0	12.0	Q1

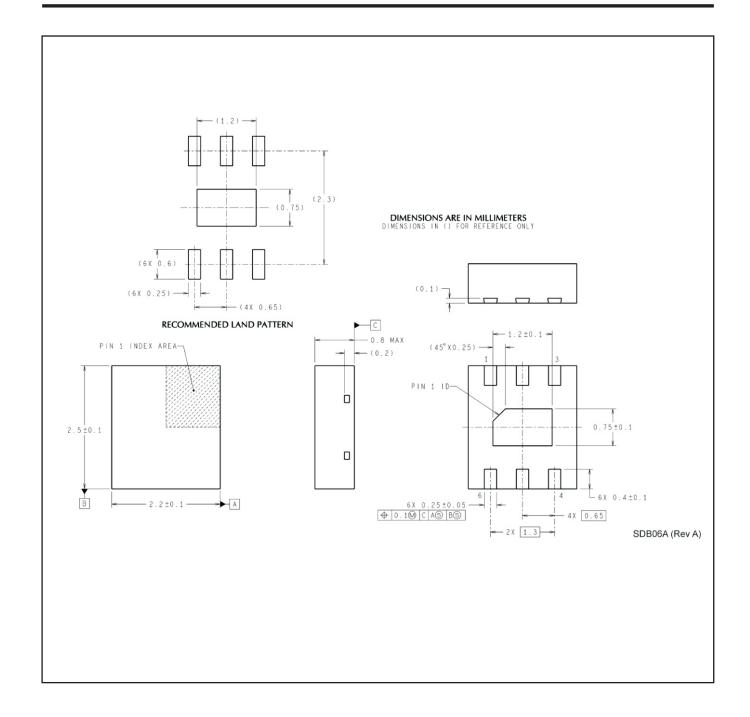
PACKAGE MATERIALS INFORMATION

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*All dimensions are nominal

	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
ı	DS38EP100SD/NOPB	WSON	NGF	6	1000	210.0	185.0	35.0



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Last updated 10/2025